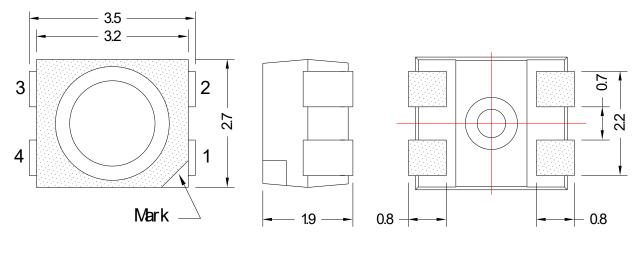
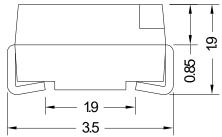
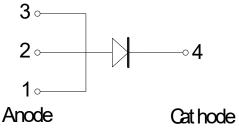


3.5 x 2.7 x 1.9mm Amber PLCC-4 SMD LED

PACKAGE DIMENSION







Item	Materials	
Package	Heat-Resistant Polymer	
Encapsulating Resin	Silicone	
Electrodes	Ag Plating Copper Alloy	
Chip	AlInGaP/Sapphire	
Emitted Color	Amber	

Notes

- 1. All dimensions are in millimeters
- 2. Electrical connection between all cathodes is recommended



3.5 x 2.7 x 1.9mm Amber PLCC-4 SMD LED

ABSOLUTE MAXIMUM RATINGS

(Ta=25°C)

	Symbol	Absolute Maximum Rating	Unit
DC Forward Current	I _F	50	mA
Peak Pulsed Forward Current	I _{FP}	100	mA
Reverse Voltage	V_{R}	5	V
Power Dissipation	Pd	125	mW
Operating temperature	T_{opr}	-30~+100	°C
Storage temperature	T_{stg}	-40~+100	°C
Solder Temperature	T_{sld}	265°C for 10 sec	

OPTICAL-ELECTRICAL CHARACTERISTICS

(Ta=25°C)

	Symbol	Test condition	Min.	Тур.	Max.	Unit
Forward Voltage	V _F			2.1	2.5	V
Luminous Flux	ΦV			3600		mlm
Luminous Intensity	lv	L = 20 m A	880	1200	1900	mcd
Dominant Wavelength	λd	I _F =20mA	610	615	620	nm
Peak Wavelength	λр			620		nm
Spectral Half Width	Δλ1/2			16		nm
Viewing Angle	201/2			120		deg
Reverse Current	I _R	V _R =5V			10	μΑ

Notes:

- 1. Measurement Uncertainty of Luminous Intensity: ±10%
- 2. Please refer to CIE1931 chromaticity diagram



3.5 x 2.7 x 1.9mm Amber PLCC-4 SMD LED

LUMINOUS INTENSITY BIN TABLE

IF=20mA

Rank Name	Min(mcd)	Max(mcd)
Р	880	1150
Q	1150	1500
R	1500	1900

Note: Tolerance for each bin limit is ±15%

COLOR BIN TABLE

IF=20mA

Rank Name	Min(nm)	Max(nm)
1	610	615
2	615	620

Note: Tolerance for each bin limit is ±1nm

Notes:

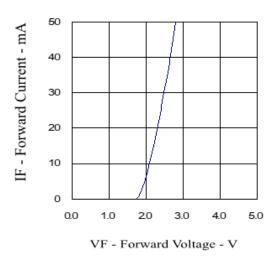
- 1. One delivery will include several color ranks and Iv ranks of products. The quantity ratio of the different rank is decided by AOP
- 2. Bin name typed on label: IV Rank + Color Rank. For example, Bin Q2 means IV: 1150~1500 mcd and Color: 615~620nm
- 3. AOP has the right to update the information without notice. Please double confirm the spec details before placing an order



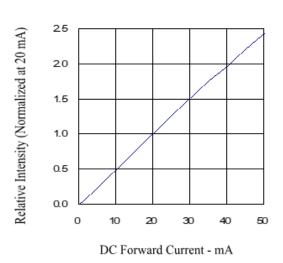
3.5 x 2.7 x 1.9mm Amber PLCC-4 SMD LED

TYPICAL ELECTRICAL-OPTICAL CHARACTERISTIC CURVES

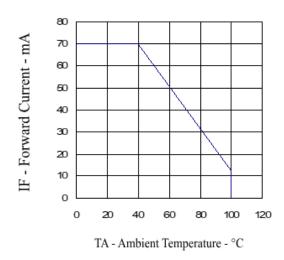
Forward Current vs. Forward Voltage



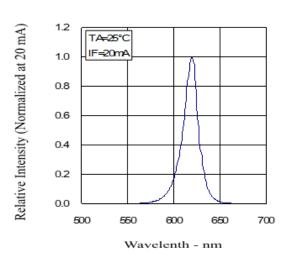
Relative Intensity vs. Forward Current



Forward Current vs. Ambient Temperature



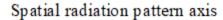
Relative Intensity vs. Wavelength

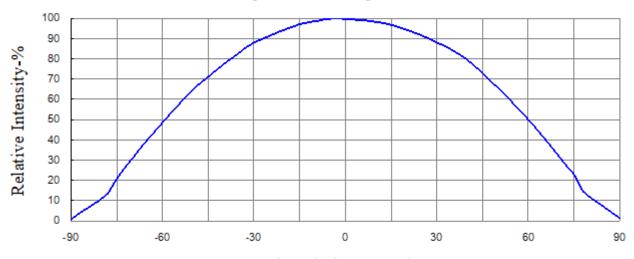




3.5 x 2.7 x 1.9mm Amber PLCC-4 SMD LED

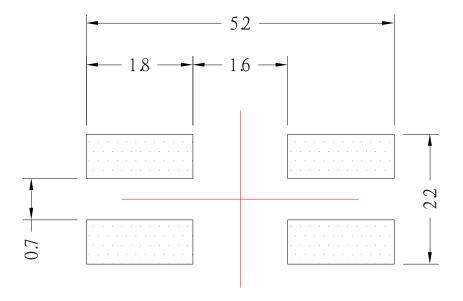
RADIATION PATTERN





Angular Displacement-degree

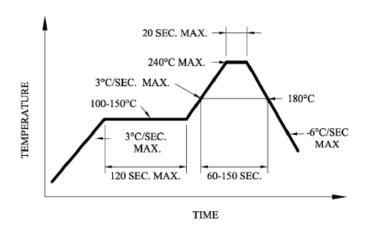
RECOMMENDED SOLDERING PAD PATTERN



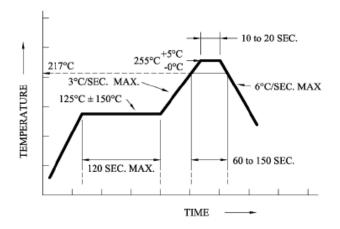


3.5 x 2.7 x 1.9mm Amber PLCC-4 SMD LED

SOLDERING CONDITIONS



Recommended reflow soldering profile



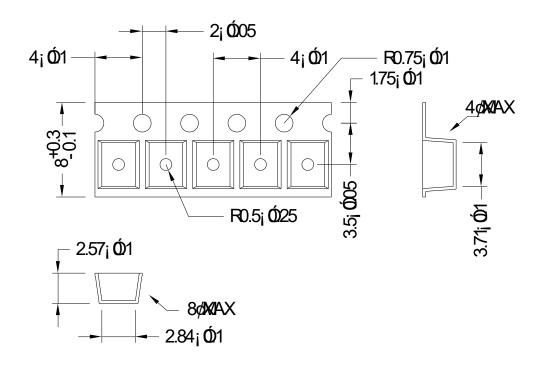
Recommended Pb-free reflow soldering profile.

- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a
 double-head soldering iron should be used. I should be confirmed beforehand whether the
 characteristics of the LEDs will or will not be damaged by repairing
- Reflow soldering should not be done more than two times
- When soldering, do not put stress on the LEDs during heating
- After soldering, do not warp the circuit board

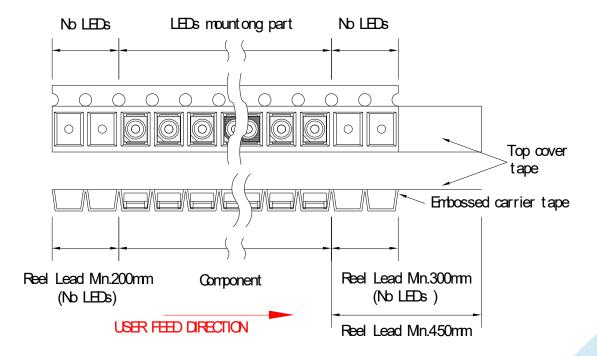


3.5 x 2.7 x 1.9mm Amber PLCC-4 SMD LED

TAPE DIMENSION



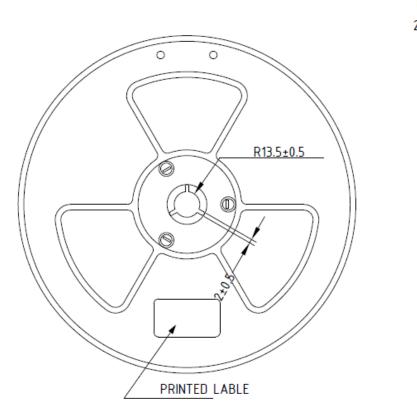
TAPE LEADER AND TRAILER DIMENSION

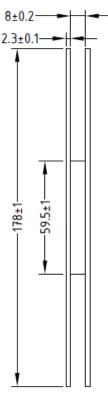




3.5 x 2.7 x 1.9mm Amber PLCC-4 SMD LED

REEL DIMENSION





Notes:

- Baking is required under the following conditions:
 The pack has been opened for more than 72 hours
- Baking recommended conditions: 60±5°C for 20 hours
- 3. 8mm tape and 7 inch reel; 2000pcs/Reel



3.5 x 2.7 x 1.9mm Amber PLCC-4 SMD LED

MOISTURE SENSITIVITY

AOP's SMD LED are shipped in sealed, moisture-barrier bags (MBB) designed for long shelf life. If SMD LED has exposed with moist environments before soldering, this may cause damage to SMD LED during soldering (reflow) operation

STORAGE / FLOOR TIME

Condition	Temperature (°C)	Humidity (RH)	Period of Time
Before Open	30	60	1year from shipping date
After Open	30	60	Within 72 hours

- MSL of this product are MSL4, please see IPC/JEDEC STD020D for more detail
- LEDs reach floor time may be damaged while soldering/reflow processing, please baking the LEDs before use
- If RH indicator card show 60% RH when unseal the package, please bake/discard the LED

RESEAL

- AOP's aluminum MBB may reuse as to reseal the unused LED If MBB has not damaged or had any holes on it
- Moisture absorbent material (Silica gel) may be reuse if it does not become pink
- Proper resealed LED's floor time will not reset, only stop counting until open
- If RH indicator card show 60% RH when open the package, please bake/discard the LED

BAKING

Condition	Temperature (°C)	Period of Time
With Reel	60	More than 24 hours, but not more than 48 hours
Without Reel	90	24 hours

- Baking of LED available ONCE only, more than nonce may damage the LEDs while baking
- Baking only required when LED reach it's floor time